

STW43NM50N

N-channel 500 V, 0.070 Ω, 37 A MDmesh™ II Power MOSFET TO-247

Features

Туре	V _{DSS @} Tjmax	R _{DS(on)} max	I _D
STW43NM50N	550 V	< 0.085 Ω	37 A

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

Application

■ Switching applications

Description

yosolete

This series of devices implements second generation MDmeshTM technology. This revolutionary Power MOSFET associates a new vertical structure to the company's strip layout to yield one of the world's lowes' concesistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

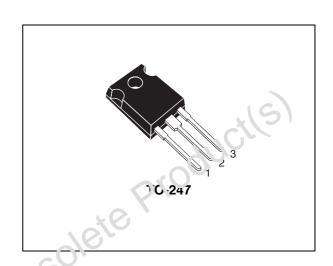


Figure 1. Internal schematic diagram

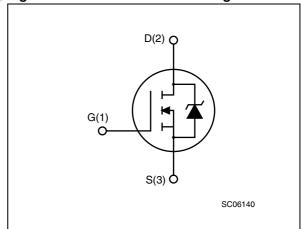


Table 1. Device summary

Order code	Marking	Package	Packaging
STW43NM50N	43NM50N	TO-247	Tube

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STW43NM50N Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	500	V
V _{GS}	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	37	Α
I _D	Drain current (continuous) at T _C = 100 °C	23	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	148	Α
P _{TOT}	Total dissipation at T _C = 25 °C	255	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	- oc to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resis and junction-case max	0.49	°C/W
Rthj-amb	Thermal esistance junction-ambient max	50	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AS}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj max)	15	Α
E _{AS}	Single pulse avalanche energy (starting T _J =25 °C, I _D =I _{AS} , V _{DD} =50 V)	1000	mJ

^{2.} $I_{SD} \leq 37$ A, di/dt ≤ 400 A/ μ s, $V_{DD} = 80\%$ $V_{(BR)DSS}$

Electrical characteristics STW43NM50N

2 Electrical characteristics

(T_{CASE}=25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	500			V
dv/dt (1)	Drain source voltage slope	V _{DD} = 400 V, I _D = 37 A, V _{GS} =10 V		30		V/ns
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating V _{DS} = Max rating, @125 °C		\C	100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V	00		100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ 5 } $		0.070	0.085	Ω

^{1.} Characteristic value at turn off on inductive load

Table 6. Dynamic

	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	g _{fs} ⁽¹⁾	Forward transcenductance	V_{DS} =15 $V_{,}$ I_{D} = 18.5 A	-	18	-	S
	C _{iss} C _{ors}	Input capacitance Cuti ut capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	1	4200 290 20		pF pF pF
0/6	C _{oss eq.} (2)	Equivalent output capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 400 V		590	-	pF
Opso	Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 400 \text{ V}, I_D = 37 \text{ A},$ $V_{GS} = 10 \text{ V},$ (see Figure 15)	-	140 72 23	-	nC nC nC
	R_{g}	Gate input resistance	f=1 MHz Gate DC Bias=0 Test signal level = 20 mV open drain	-	1.4	-	Ω

^{1.} Pulsed: Pulse duration = 300 µs, duty cycle 1.5%

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{matrix} t_{\rm d(on)} \\ t_{\rm r} \\ t_{\rm d(off)} \\ t_{\rm f} \end{matrix}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 250 \text{ V}, I_{D} = 18.5 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$ (see Figure 14)	-	30 20 140 42	-	ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)		-	. \C	37 148	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 37 \text{ A}, V_{GS} = 0$	-0		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} = 37 A, di/dt = 100 A/, is V _{DD} = 60 V (see Figure 16)	6	530 11 42		ns μC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 37 \text{ A. c}^{i}/d' = 100 \text{ A/}\mu\text{s}$ $V_{DD} = (0)^{i}, T_{j} = 150 ^{\circ}\text{C}$ (Se3 Figure 16)	1	630 14 45		ns μC A

Pulse width limited by safe operating area

^{2.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

STW43NM50N **Electrical characteristics**

Electrical characteristics (curves) 2.1

Figure 2. Safe operating area

Figure 3. Thermal impedance

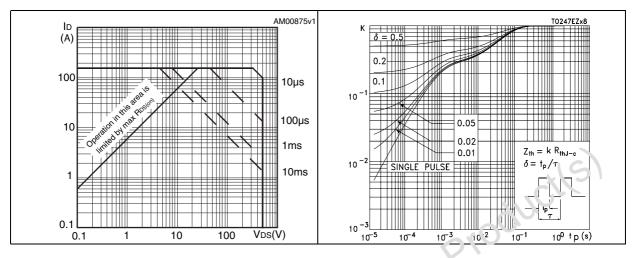


Figure 4. **Output characteristics**

Figure 5. Transfer characteristics

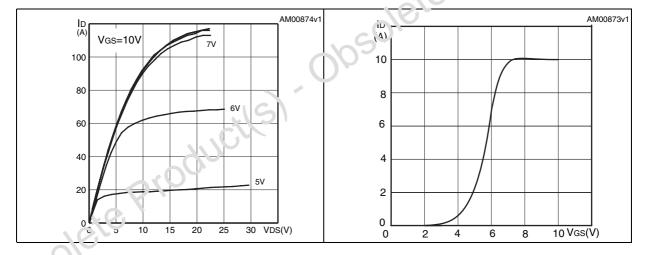


Figure S. **Transconductance**

Figure 7. Static drain-source on resistance

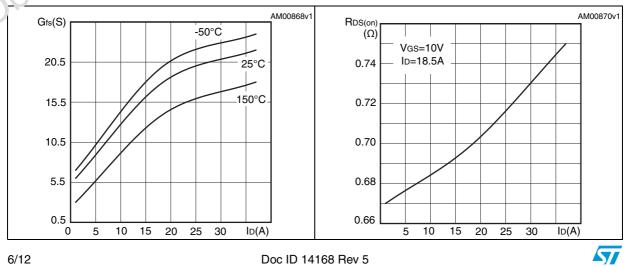


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

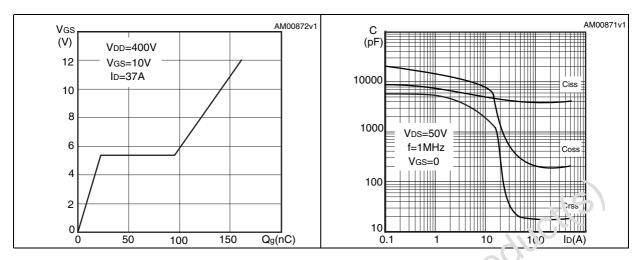


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

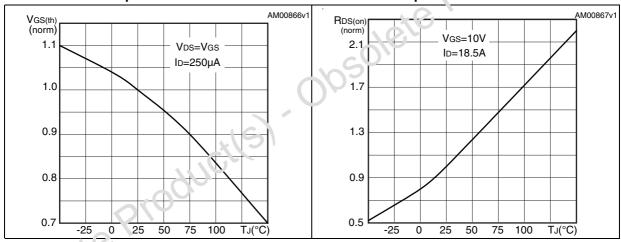
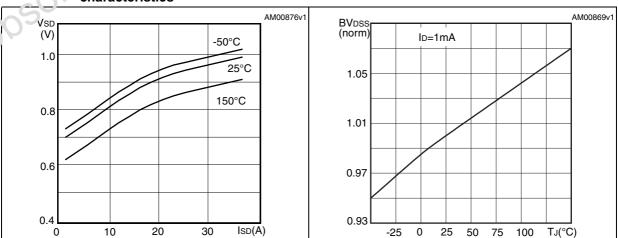


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized B_{VDSS} vs temperature



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Test circuits STW43NM50N

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

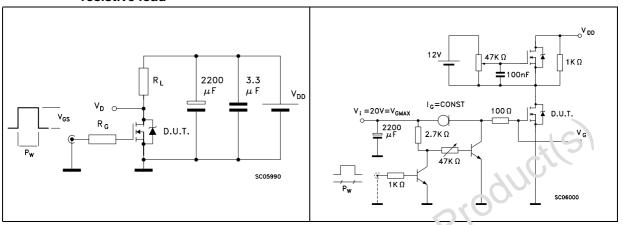


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test

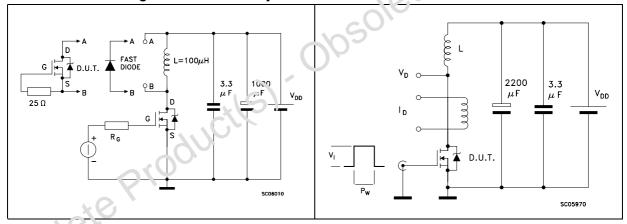
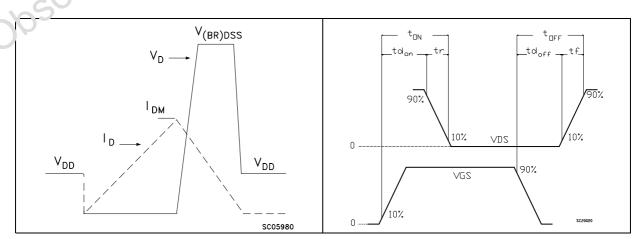


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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4 Package mechanical data

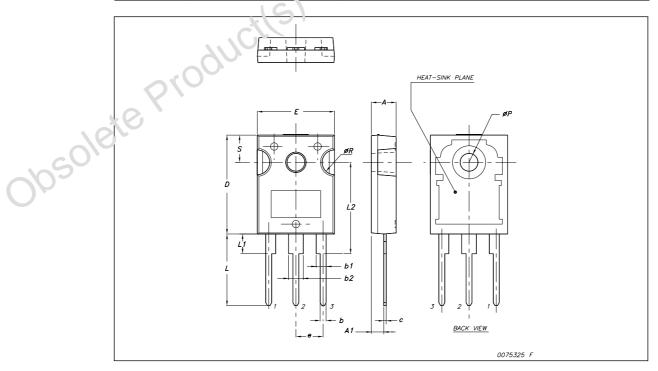
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Dim.		mm.		
Diiii.	Min.	Тур	Max.	
Α	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.60	
D	19.85		?∂.15	
E	15.45		15.75	
е		5.45		
L	14.20	1.0.	14.80	
L1	3.70	1010	4.30	
L2		\6.50		
øΡ	3.55	102	3.65	
øR	4.50) (5.50	
S		5.50		



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STW43NM50N Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
15-Nov-2007	1	First release
04-Aug-2008	2	Document status promoted from preliminary data to datasheet
15-Oct-2008	3	2.1: Electrical characteristics (curves) has been corrected
27-Jan-2009	4	V _{GS} value has been corrected in <i>Table 2</i>
08-Jan-2010	5	Updated V _{GS} on <i>Table 2: Absolute maximum ratings</i> .
27-Jan-2009 4 V _{GS} value has been corrected in <i>Table 2</i> 08-Jan-2010 5 Updated V _{GS} on <i>Table 2: Absolute maximum ratings</i> .		

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